FAIRCHILD SEMICONDUCTOR™

April 1984
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DM74AS169A
Synchronous 4-Bit Binary Up/Down Counter

General Description

These synchronous presettable counters feature an internal carry look ahead for cascading in high speed counting applications. The DM74AS169 is a 4-bit binary up/down counter. The carry output is decoded to prevent spikes during normal mode of counting operation. Synchronous operation is provided so that outputs change coincident with each other when so instructed by count enable inputs and internal gating. This mode of operation eliminates the output counting spikes which are normally associated with asynchronous (ripple clock) counters. A buffered clock input triggers the four flip-flops on the rising (positive going) edge of clock input waveform.

These counters are fully programmable; that is, the outputs may each be preset either HIGH or LOW. The load input circuitry allows loading with carry-enable output of cascaded counters. As loading is synchronous, setting up a LOW level at the load input disables the counter and causes the outputs to agree with the data inputs after the next clock pulse.

The carry look-ahead circuitry permits cascading counters for n-bit synchronous applications without additional gating. Both count enable inputs ($\overline{P}$ and $\overline{T}$) must be LOW to count. The direction of the count is determined by the level of the up/down input. When the input is HIGH, the counter counts UP; when LOW, it counts DOWN. Input T is fed forward to enable the carry outputs. The carry output thus enabled will produce a LOW level output pulse with a duration approximately equal to the HIGH portion of the QA output when counting UP, and approximately equal to the LOW portion of the QA output when counting DOWN. This LOW level overflow carry pulse can be used to enable successively cascaded stages. Transitions at the enable $\overline{P}$ or $\overline{T}$ inputs are allowed regardless of the level of the clock input.

The control functions for these counters are fully synchronous. Changes at control inputs (enable $\overline{P}$, enable $\overline{T}$, load, up/down) which modify the operating mode have no effect until clocking occurs. The function of the counter (whether enabled, disabled, loading or counting) will be dictated solely by the conditions meeting the stable setup and hold times.

Features

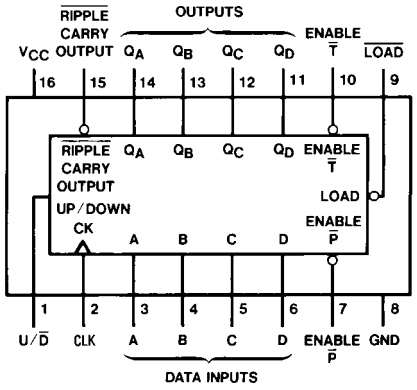
- Switching Specifications at 50 pF
- Switching Specifications guaranteed over full temperature and V_{CC} range
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Functionally and pin-for-pin compatible with Schottky and low power Schottky TTL counterpart
- Improved AC performance over Schottky and low power Schottky counterparts
- Synchronously programmable
- Internal look ahead for fast counting
- Carry output for n-bit cascading
- Synchronous counting
- Load control line
- ESD inputs

Ordering Code:

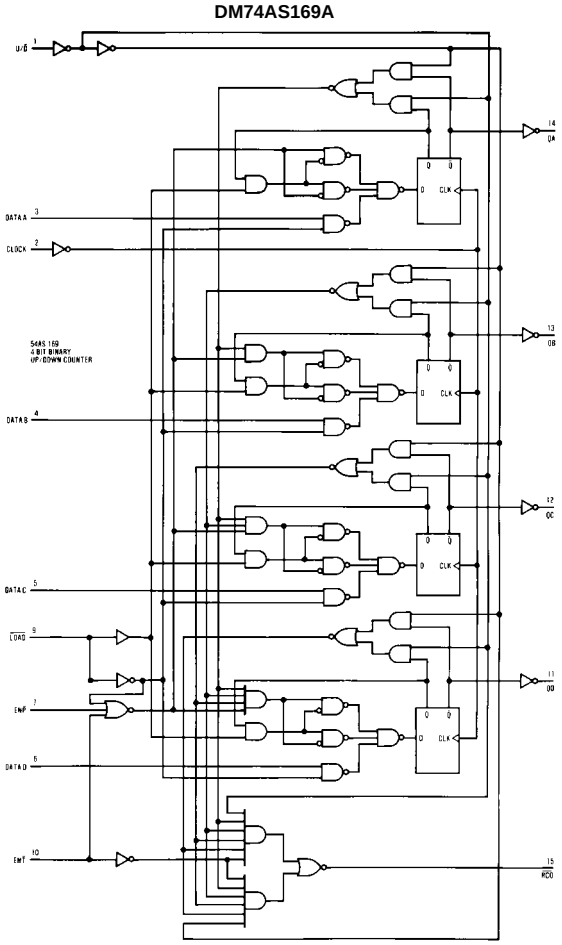
Order Number	Package Number	Package Description
DM74AS169AM	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74AS169AN	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Logic Diagram



Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C
Typical θ_{JA}	
N Package	71.5°C/W
M Package	101.0°C/W

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter		Min	Nom	Max	Units
V_{CC}	Supply Voltage		4.5	5	5.5	V
V_{IH}	HIGH Level Input Voltage		2			V
V_{IL}	LOW Level Input Voltage				0.8	V
I_{OH}	HIGH Level Output Current				−2	mA
I_{OL}	LOW Level Output Current				20	mA
f_{CLK}	Clock Frequency		0		75	MHz
t_{SU}	t_{setup}, Set-up Time	Data; A, B, C, D	8			ns
		En $\overline{P}$, En $\overline{T}$	8			ns
		$\overline{LOAD}$	8			ns
		U/$\overline{D}$	11			ns
t_H	t_{hold}, Hold Time	Data; A, B, C, D	0			ns
		En $\overline{P}$, En $\overline{T}$	0			ns
		$\overline{LOAD}$	0			ns
		U/$\overline{D}$	0			ns
t_{WCLK}	Width of Clock Pulse		6.7			ns
t_A	Free Air Operating Temperature		0		70	°C

Electrical Characteristics

over recommended operating free air temperature range. All typical values are measured at V_{CC} = 5V, T_A = 25°C

Symbol	Parameter	Conditions		Min	Typ	Max	Units
V_{IK}	Input Clamp Voltage	V_{CC} = 4.5V, I_I = −18 mA				−1.2	V
V_{OH}	HIGH Level Output Voltage	I_{OH} = −2 mA, V_{CC} = 4.5V to 5.5V		V_{CC} − 2			V
V_{OL}	LOW Level Output Voltage	V_{CC} = 4.5V, I_{OL} = 20 mA			0.35	0.5	V
I_I	Input Current @ Max Input Voltage	V_{CC} = 5.5V, V_{IH} = 7V	$\overline{LOAD}$, $\overline{ENT}$, U/$\overline{D}$			0.2	mA
			Others			0.1	
I_{IH}	HIGH Level Input Current	V_{CC} = 5.5V, V_{IH} = 2.7V	$\overline{LOAD}$, $\overline{ENT}$, U/$\overline{D}$			40	μA
			Others			20	
I_{IL}	LOW Level Input Current	V_{CC} = 5.5V, V_{IL} = 0.4V	CLK, DATA, $\overline{ENP}$			−0.5	mA
			$\overline{LOAD}$, $\overline{ENT}$, U/$\overline{D}$			−1	
I_O (Note 2)	Output Drive Current	V_{CC} = 5.5V, V_O = 2.25V		−30		−112	mA
I_{CC}	Supply Current	V_{CC} = 5.5V			46	63	mA

Note 2: The output conditions have been chosen to produce a current that closely approximates one half of the true short circuit output current, I_{OS}.

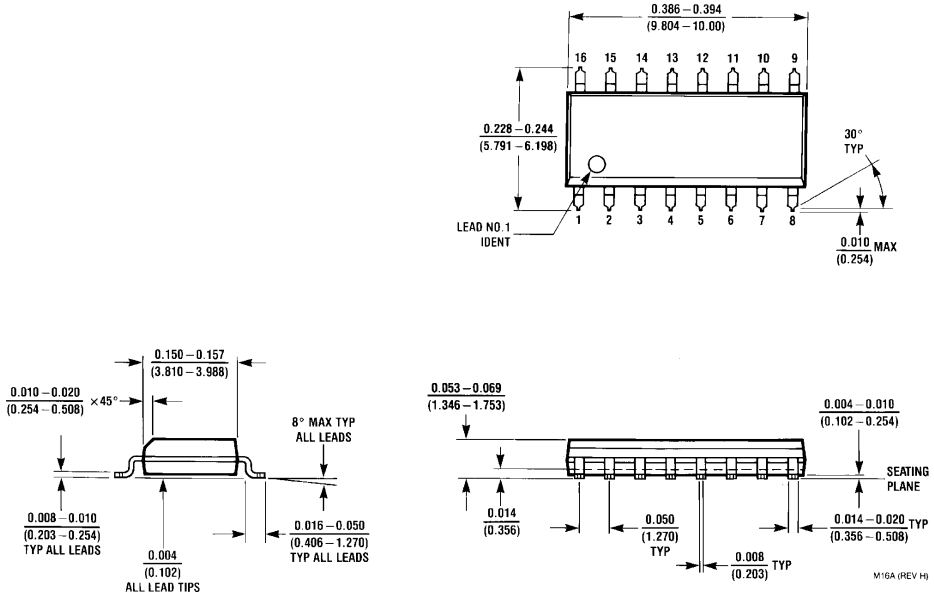
Switching Characteristics

over recommended operating free air temperature range

Symbol	Parameter	Conditions	From	To	Min	Max	Units
f_{MAX}	Maximum Clock Frequency	V_{CC} = 4.5V to 5.5V			75		MHz
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	R_L = 500Ω C_L = 50 pF	Clock	$\overline{\text{RIPPLE}}$ Carry	3	16.5	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output		Clock	$\overline{\text{RIPPLE}}$ Carry	2	13	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output		Clock	Any Q	1	7	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output		Clock	Any Q	2	13	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output		En $\overline{T}$	$\overline{\text{RIPPLE}}$ Carry	1.5	9	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output		En $\overline{T}$	$\overline{\text{RIPPLE}}$ Carry	1.5	9	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output		U/$\overline{D}$ (Note 3)	$\overline{\text{RIPPLE}}$ Carry	2	12	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output		U/$\overline{D}$ (Note 3)	$\overline{\text{RIPPLE}}$ Carry	2	13	ns

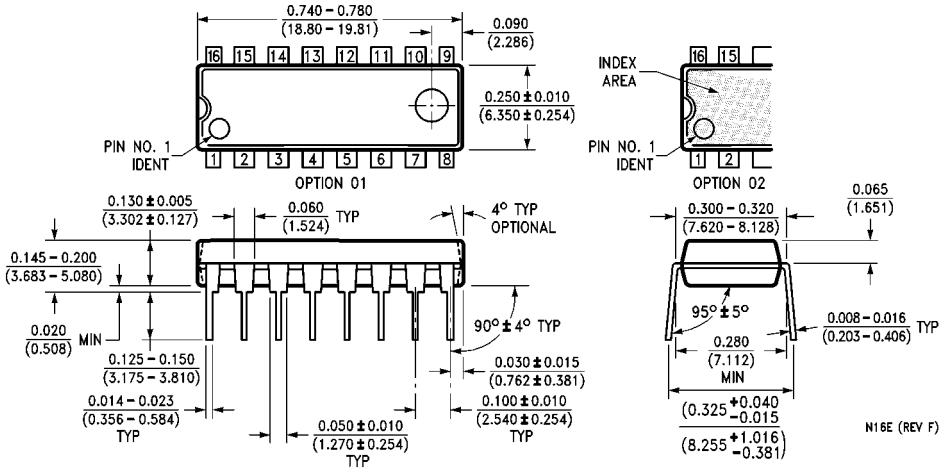
Note 3: Propagation delay time from up/down to ripple carry must be measured with the counter at either a minimum or a maximum count. As the logic level of the up/down input is changed, the ripple carry output will follow. If the count is minimum (0), the ripple carry output transition will be in phase. If the count is maximum, the ripple carry output will be out of phase.

Physical Dimensions inches (millimeters) unless otherwise noted



16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N16E